

Title (en)  
PHENOLIC RESIN METHOD

Title (de)  
PHENOLHARZVERFAHREN

Title (fr)  
PROCÉDÉ À BASE DE RÉSINE PHÉNOLIQUE

Publication  
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Application  
**EP 16730241 A 20160518**

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Abstract (en)  
[origin: WO2016184448A1] The invention relates to a method, a device, a binder system (400) and a material system for producing components (103) using layering technology, wherein the temperature in the building space and/or in the applied material is set to at least 70 °C and maintained for at least 2 hours, and wherein the areas, on which binder (400) has been selectively applied, solidify and form the component (103).

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